

Title (en)  
COMPONENT WITH TOP LAYER OF A PA613 MOULDING COMPOUND

Title (de)  
BAUTEIL MIT DECKSCHICHT AUS EINER PA613-FORMMASSE

Title (fr)  
COMPOSANT AVEC COUCHE DE COUVERTURE CONSTITUÉE D'UNE MATIÈRE MOULABLE PA613

Publication  
**EP 2291286 A1 20110309 (DE)**

Application  
**EP 09769217 A 20090623**

Priority  
• EP 2009057750 W 20090623  
• DE 102008002599 A 20080624

Abstract (en)  
[origin: CA2724526A1] A component which comprises the following components: I. a top layer of a moulding compound which contains at least 50% by weight of PA613 and II. a substrate of a thermoplastic moulding compound has a surface with high scratch resistance and high chemical resistance.

IPC 8 full level  
**B32B 27/34** (2006.01); **C08L 77/06** (2006.01)

CPC (source: EP US)  
**B32B 7/12** (2013.01 - EP US); **B32B 25/042** (2013.01 - EP US); **B32B 25/08** (2013.01 - EP US); **B32B 27/08** (2013.01 - EP US); **B32B 27/18** (2013.01 - EP US); **B32B 27/20** (2013.01 - EP US); **B32B 27/281** (2013.01 - EP US); **B32B 27/286** (2013.01 - EP US); **B32B 27/302** (2013.01 - EP US); **B32B 27/308** (2013.01 - EP US); **B32B 27/32** (2013.01 - EP US); **B32B 27/34** (2013.01 - EP US); **B32B 27/365** (2013.01 - EP US); **B32B 27/38** (2013.01 - EP US); **B32B 27/40** (2013.01 - EP US); **C08L 77/06** (2013.01 - EP US); **G02B 1/04** (2013.01 - EP US); **B32B 2307/3065** (2013.01 - EP US); **B32B 2307/402** (2013.01 - EP US); **B32B 2307/4026** (2013.01 - EP US); **B32B 2307/412** (2013.01 - EP US); **B32B 2307/558** (2013.01 - EP US); **B32B 2307/584** (2013.01 - EP US); **B32B 2307/714** (2013.01 - EP US); **B32B 2451/00** (2013.01 - EP US); **B32B 2457/20** (2013.01 - EP US); **B32B 2605/00** (2013.01 - EP US); **Y10T 428/31507** (2015.04 - EP US); **Y10T 428/31511** (2015.04 - EP US); **Y10T 428/31533** (2015.04 - EP US); **Y10T 428/31562** (2015.04 - EP US); **Y10T 428/31721** (2015.04 - EP US); **Y10T 428/31725** (2015.04 - EP US); **Y10T 428/31728** (2015.04 - EP US); **Y10T 428/31736** (2015.04 - EP US); **Y10T 428/3175** (2015.04 - EP US)

C-Set (source: EP US)  
**G02B 1/04 + C08L 77/00**

Citation (search report)  
See references of WO 2009156368A1

Designated contracting state (EPC)  
AT BE BG CH CY CZ DE DK EE ES FI FR GB GR HR HU IE IS IT LI LT LU LV MC MK MT NL NO PL PT RO SE SI SK TR

Designated extension state (EPC)  
AL BA RS

DOCDB simple family (publication)  
**DE 102008002599 A1 20091231**; BR PI0914201 A2 20190312; CA 2724526 A1 20091230; CN 102076497 A 20110525; EP 2291286 A1 20110309; JP 2011525438 A 20110922; JP 5523453 B2 20140618; KR 20110048488 A 20110511; US 2011045269 A1 20110224; WO 2009156368 A1 20091230

DOCDB simple family (application)  
**DE 102008002599 A 20080624**; BR PI0914201 A 20090623; CA 2724526 A 20090623; CN 200980124077 A 20090623; EP 09769217 A 20090623; EP 2009057750 W 20090623; JP 2011515339 A 20090623; KR 20107026302 A 20090623; US 98989909 A 20090623